

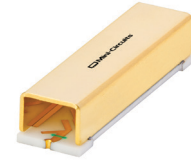
Surface Mount Thin-Film Filters

50Ω

DC to 40 GHz

The Big Deal

- Low passband insertion loss
- High rejection
- Good power handling
- Temperature stability -55°C to 125°C
- High repeatability
- RoHS complaint
- Small size



Product Overview

Mini-Circuits' *Surface Mount Thin-Film filters* offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee an enhanced Q and repeatable performance.

Low pass, high pass and bandpass surface mount thin-film designs can be realized with this technology. Using thin-film manufacturing, we can guarantee repeatability on large batches of filters. Thin-film filters are small in size with high-quality, precise machining for applications where size is critical.

Key Features

Feature	Advantages
Low insertion loss	High Q material and sputtering process results in lower insertion loss, better SNR is obtained.
Fast roll-off (steeper skirts)	High selectivity results in better adjacent channel rejection and dynamic range
Wider stopband	Wide spur-free stopband results in better adjacent channel rejection and dynamic range
Temperature stability	Very minimal change in electrical performance across temperature makes these filters suitable for a wide range of operating conditions.
Small Size	Various design techniques are employed to realize small size.

Notes

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Bandpass Filter

50Ω 24250 to 27500 MHz

ABF-26G+



Generic photo used for illustration purposes only

CASE STYLE: VG3044

Features

- Low mid band insertion loss of 1.8 dB typ.
- 15 dB typ. return loss in entire passband
- 60 dB typ. rejection
- Shielded component

Applications

- n258
- 5G Telecommunication

Electrical Specifications⁽¹⁾ at 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	F _c	25875	—	1.8	3.0	dB
	Insertion Loss	F1-F2	24250 - 27500	—	3.5	—	dB
Stop Band, Lower	Return Loss	F1-F2	24250 - 27500	—	15	—	dB
		DC-F3	DC - 20000	30	45	—	dB
Stop Band, Lower	Insertion Loss	F3-F4	20000 - 22500	25	45	—	dB
		F5-F6	29250 - 31000	25	45	—	dB
Stop Band, Upper	Insertion Loss	F6-F7	31000 - 35000	40	60	—	dB
		F7-F8	35000 - 40000	—	40	—	dB

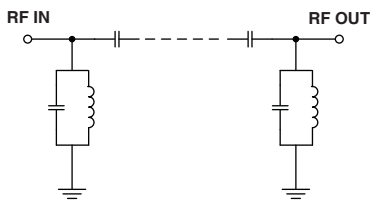
1. Measured on Mini-Circuits Characterization Test Board TB-ABF-26G+

Maximum Ratings

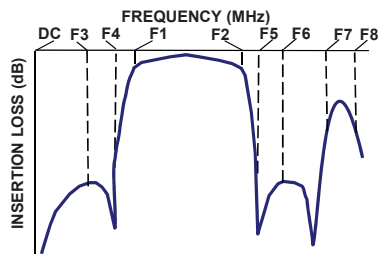
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input	1W Max. @ 25°C

Permanent damage may occur if any of these limits are exceeded.

Functional Schematic



Typical Frequency Response

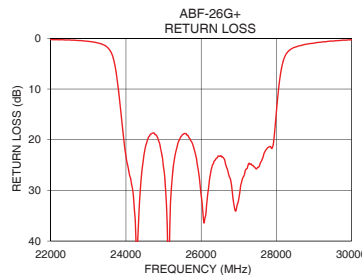
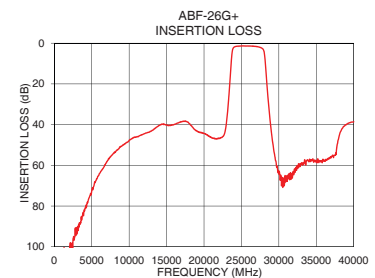
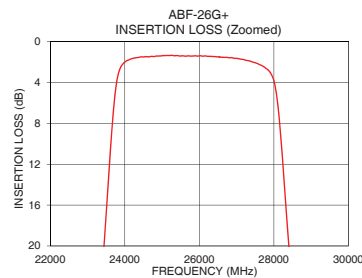


Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	114.71	0.03
1000	105.71	0.21
10000	47.76	0.06
20000	44.38	0.23
22500	45.94	0.32
23225	30.43	0.87
23450	19.55	1.45
23825	3.17	11.78
24250	1.61	36.24
25875	1.40	23.68
26000	1.39	30.94
27000	1.63	31.78
27500	2.07	25.48
27900	3.01	21.48
28400	19.95	2.08
28625	30.01	1.46
29250	50.51	0.68
31000	65.18	0.05
35000	57.52	0.50
40000	38.60	0.74

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Notes

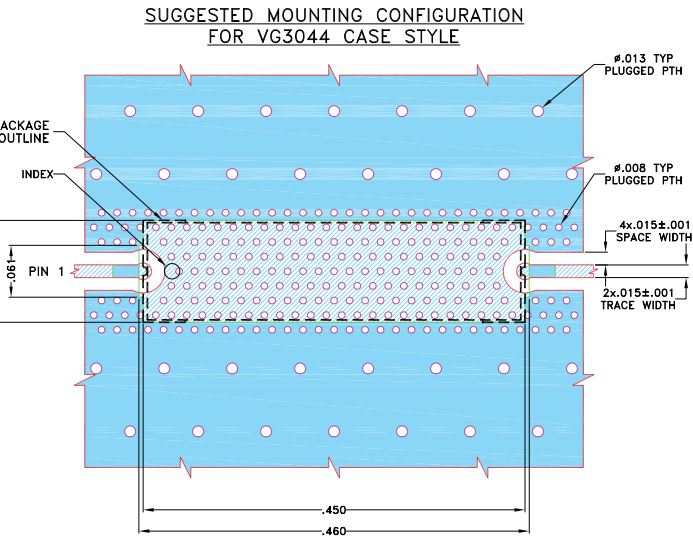
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Pad Connections

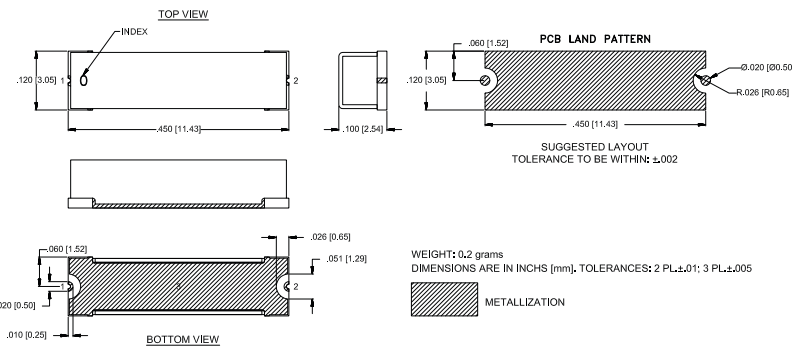
RF IN	1
RF OUT	2
GROUND	3

Demo Board MCL P/N: TB-ABF-26G+
Suggested PCB Layout (PL-713)



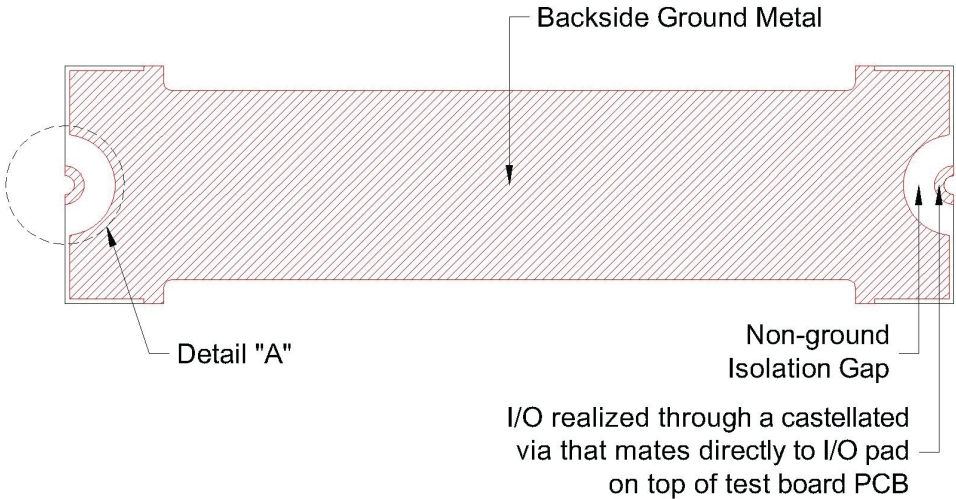
- NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
■ DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Outline Drawing



Recommendations of PCB pattern at customer board

Filter Back side

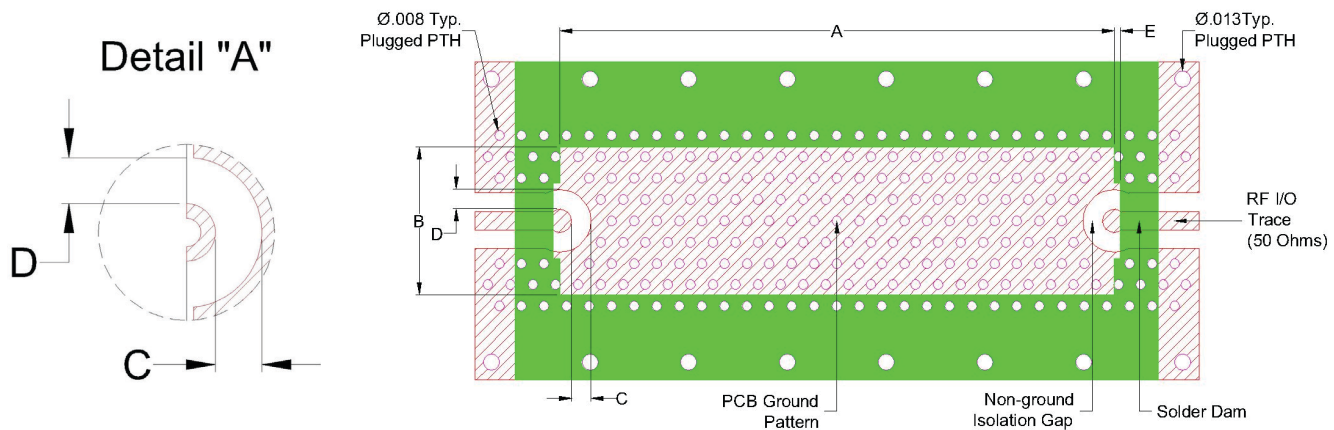


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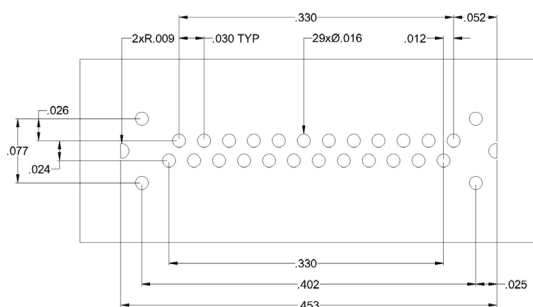


- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use solder mask at Customer PCB at outer area of filter pattern/footprint without any clearance.
- 5) Recommended to use Solder mask at I/O of Customer PCB with 5 mil clearance from filter I/O edge (dimension E)

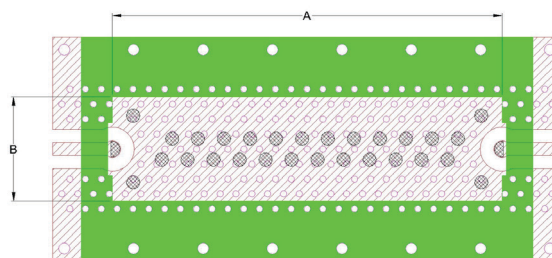
Comments on component handling and solder attach

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing



Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- 5) Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

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